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1. GENERAL SPECIFICATIONS

1.1 DATA SHEETS FOR CONTROLLER / DRIVER PLEASE REFER TO:

HIMAX HX83192-C OR EQUIVALENT

1.2 MATERIAL SAFETY DESCRIPTION

ASSEMBLIES SHALL COMPLY WITH EUROPEAN ROHS REQUIREMENTS, INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD, MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED BIPHENYLS (PBB) AND POLYBROMINATED DIPHENYL ETHERS (PBDE), BIS(2-ETHYLHEXYL) PHTHALATE (DEHP), BUTYL BENZYL PHTHALATE (BBP), DIBUTYL PHTHALATE (DBP), DIISOBUTYL PHTHALATE (DIBP).

2. MECHANICAL SPECIFICATIONS

2.1 TFT LCD MODULE MECHANICAL SPECIFICATIONS

(1) DISPLAY SIZE	12.3 inch
(2) NUMBER OF DOTS	1920(RGB)W * 720H DOTS
(3) MODULE SIZE	318.03W * 138.51H * 14.2D(MAX.) mm
	(WITHOUT FPC)
(4) ACTIVE AREA	292.032W * 109.512H mm
(5) DOT SIZE	0.0507W * 0.1521H mm
(6) PIXEL SIZE	0.1521W * 0.1521H mm
(7) LCD TYPE	TFT, IPS, TRANSMISSIVE, NORMALLY
	BALCK
(8) COLOR	16.7M
(9) VIEWING DIRECTION	SUPER WIDE VIEW
(10) BACKLIGHT	LED , COLOR : WHITE
(11) INTERFACE MODE	LVDS(VESA)
(12) WEIGHT	TBD

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2.2 CAPACITIVE TOUCH PANEL MECHANICAL SPECIFICATIONS

(1) TOUCH PANEL SIZE	- 318.03W * 138.51H mm (WITHOUT FPC) - 292.032W * 109.512H mm - MULTI TOUCH
(5) NUMBER OF TOUCH SENSOR (6) RESOULTION (7) INTERFACE MODE (8) THE MATERIAL OF COVER LENS	S Cotto talion in the state of

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3. ABSOLUTE MAXIMUM RATINGS

3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	MIN.	MAX.	UNIT	REMARK
	VDD-VSS		3.6	V	_
POWER SUPPLY VOLTAGE	AVDD-VSS	-0.3	7	V	_
	AVEE-VSS	-7.3	0.3	V	_
STATIC ELECTRICITY	_	_	_	V	NOTE (1)

NOTE (1): LCM SHOULD BE GROUND DURING LCM HANDLING.

NOTE (2): THE ABSOLUTE MAXIMUM RATING VALUES OF THIS PRODUCT ARE NOT ALLOWED TO BE EXCEEDED AT ANY TIMES. SHOULD A MODULE BE USED WITH ANY OF THE ABSOLUTE MAXIMUM RATINGS EXCEEDED, THE CHARACTERISTICS OF THE MODULE MAY NOT BE RECOVERED, OR IN AN EXTREME CASE, THE MODULE MAY BE PERMANENTLY DESTROYED.

3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

ITEM	OPERATING		STORAGE		REMARK	
I I EIVI	MIN.	MAX.	MIN.	MAX.	KEWAKK	
AMBIENT TEMPERATURE	(-20°C)	(70°C)	(-30°C)	(80°C)	NOTE (1),(2),(3)	
HUMIDITY	NOTI	7(2)	NOT	E(2)	WITHOUT	
HOMIDITY	NOTE (3)		NOTE (3)		CONDENSATION	
CORROSIVE GAS	NOT ACC	EPTABLE	NOT ACC	EPTABLE		

NOTE (1): THE ABSOLUTE MAXIMUM RATINGS OF THIS PRODUCT SHOULD NOT BE EXCEEDED AT ANY TIME. IF THESE RATINGS ARE EXCEEDED, THE PRODUCT'S PERFORMANCE IS NOT GUARANTEED AND THE PRODUCT MAY EXPERIENCE PERMANENT DAMAGE.

NOTE (2) : BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT TEMPERATURE THIS PHENOMENON IS REVERSIBLE.

NOTE (3): $Ta \le 60^{\circ}C : 90\%RH MAX$.

Ta > 60°C : ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY OF 90%RH AT 60°C.

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4. ELECTRICAL CHARACTERISTICS

 $Ta = 25 \, ^{\circ}C$

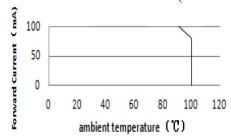
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
	STNIBOL	CONDITION	IVIIIN.	HIP.	WAA.	UNII	KEMAKK
POWER SUPPLY VOLTAGE	VDD-VSS		(3.0)	(3.3)	(3.6)	V	
POWER SUPPLY VOLTAGE FOR LED DRIVER	VBL+-VBL-		_	(12)		V	
POWER SUPPLY VOLTAGE FOR	AVDD -VSS		(6.0)	(6.5)	(7.0)	V	
CIRCUITS	AVEE -VSS		(-7.0)	(-6.5)	(-6.0)	V	
INPUT HIGH LEVEL VOLATGE	VIH	ALL INPUT PAD WITH	0.7VDD		VDD	4 v	
INPUT LOW LEVEL VOLTAGE	VIL	VDD	0		0.3VDD	V	
POWER SUPPLY CURRENT	IDD	VDD- VSS=(3.30)V		(116)	TBD		
POWER SUPPLY CURRENT FOR	IAVDD	AVDD- VSS=(6.5)V	_	(71)	TBD	mA	NOTE (1)
CIRCUITS	IAVEE	AVEE-VSS= (-6.5)V	· —	(76)	TBD),	
POWER SUPPLY CURRENT FOR LED DRIVER	IBL+	VBL+-VBL- =12V LED B/L=ON PWM=100%	- 5	(1200)	DOTT	mA	
	DI EN	VIH	(1.6)	×-0	_	V	
POWER SUPPLY	BL_EN	VIL) _	-	(0.8)	V	
VOLTAGE FOR LED DRIVER	DI DWA	VIH	(1.6)	9-		V	
DKIVEK	BL_PWM	VIL	-:0	_	(0.8)	V	
LED LIFE TIME	_	(IF=100mA) (PER LED)	(50K)	_	_	HRS	NOTE (4) NOTE (5)

NOTE (1): THE DISPLAY PATTERN IS ALL "WHITE".

NOTE (2): INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT



NOTE (3): AMBIENT TEMP. VS. ALLOWABLE FORWARD CURRENT.(PER LED)



NOTE (4): CONDITIONS; Ta=25 °C, CONTINUOUS LIGHTING.

NOTE (5): DEFINITIONS OF LIFE TIME

LCD LUMINANCE BECOMES HALF OF THE INITIAL VALUE.

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5. TIMING CHARACTERISTICS

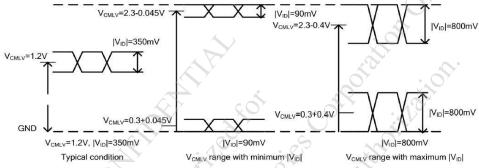
5.1 SIGNAL ELECTRICAL CHARACTERISTICS

5.1.1 SIGNAL ELECTRICAL CHARACTERISTICS FOR LVDS RECEIVER

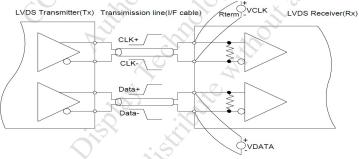
ITEM	SYMBOL	SPEC.				
I I EIVI	SIMBOL	MIN.	TYP.	MAX.	UNIT	
POSITIVE-GOING INPUT THRESHOLD VOLTAGE	V_{TH}	_	_	90	mV	
NEGATIVE-GOING INPUT THRESHOLD VOLTAGE	V_{TL}	-90	_	_	mV	
LVDS DIFFERENTIAL VOLTAGE	$ V_{\text{ID}} $	90	350	800	mV	
LVDS INPUT COMMON MODE VOLTAGE	V_{CMLY}	03+ V _{ID} /2	_	2.3- V _{ID} /2	V	

NOTE:(1)REQUIREMENT OF TERMINATION RESISTANCE(Ω): 80(MIN.)/100(TYP.)/120(MAX).

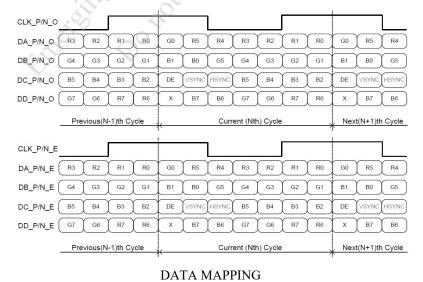
- (2)TEST CONDITIONS: VCMLV=1.2V, VDD1=2.7V~3.6V.
- (3)TEST CONDITION: TEST POINT IS IC PAD.



LVDS RECEIVER INPUT SIGNAL LEVELS

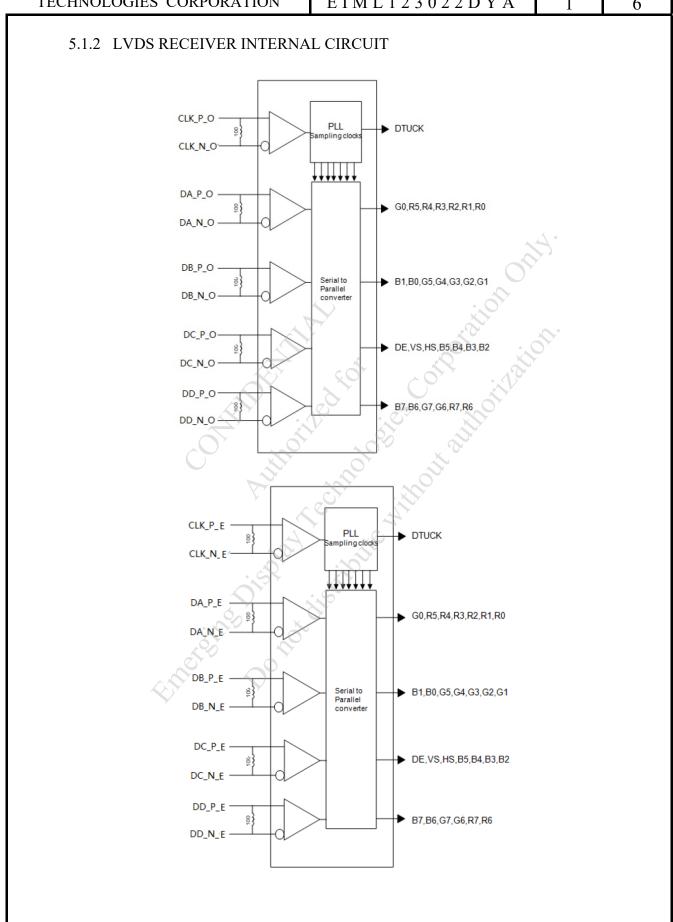


MEASUREMENT SYSTEM



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5.1.3 LVDS INTERFACE TIMING

					1
ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
H TOTAL TIME	HT	1992	2038	2112	CLOCKS
H ACTIVE TIME	HA		1920		CLOCKS
H FRONT PORCH	THFP	20	56	110	CLOCKS
H SYNC PULSE WIDTH	HSPW	32	32	32	CLOCKS
H BACK PORCH	THBP	20	30	50	CLOCKS
V TOTAL TIME	VT	850	850	850	LINES
V ACTIVE TIME	VA		720		LINES
V FRONT PORCH	TVFP	120	120	120	LINES
V SYNC PULSE WIDTH	VSPW	2	2	2	LINES
V BACK PORCH	TVBP	8	8	8	LINES
					Hz
FRAME RATE PIXEL CLOCK FREQUENCY NOTE(1): HT*VT*FV<107.71 MHz NOTE(2): ALL RELIABILITIES ARE SPEC RATE OF 60HZ. A1233H R2-P IS RATE;	FCLK	(101.59)	(103.94)	(107.71)	MHz
NOTE(1): HT*VT*FV<107.71 MHz	1 CLK	(101.57)	(103.54)	(107.71)	TVITIZ
NOTE(1). III * V I * I V > IU/./I WIIIZ	TELED EOD	ED ADIO ODE	CIFIC (TIO)	I D A GED ON	DEEDEGII
NOTE(2): ALL RELIABILITIES ARE SPEC	THED FOR	TIMING SPE	CIFICATION	BASED ON	
RATE OF 60HZ. A1233H R2-P IS	S SECURED (ONLY FOR I	FUNCTION U	JNDER LOW	/ER REFRES
RATE;	Y		_0'	·, O'	
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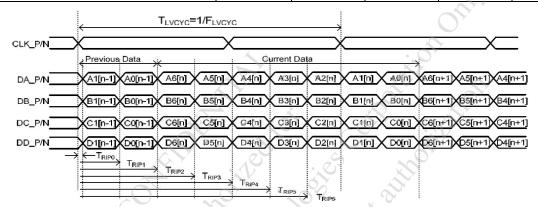
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5.2 AC CHARACTERISTICS

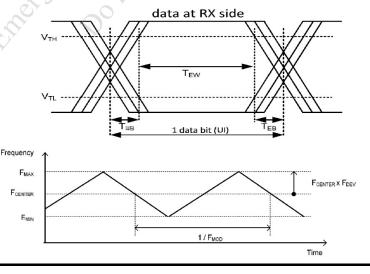
5.2.1 AC CHARACTERISTICS-1

ITEM	SYMBOL		SPEC.		UNIT
CLOCK FREQUENCY	F_{LVCYC}	MIN.	TYP.	MAX.	UNII
CLOCK PERIOD	T_{LVCYC}	_	_	140	MHZ
1 DATA BIT TIME	UI	7.14	_	_	ns
INPUT DATA POSITION FOR BIT0	T_{RIP0}	_	1/7	_	T_{LVCYC}
INPUT DATA POSITION FOR BIT1	T _{RIP1}	-T _{EB}	0	+T _{EB}	UI
INPUT DATA POSITION FOR BIT2	T_{RIP2}	$1-T_{\mathrm{EB}}$	1	$1+T_{EB}$	UI
INPUT DATA POSITION FOR BIT3	T_{RIP3}	$2-T_{\mathrm{EB}}$	2	$2+T_{EB}$	UI
INPUT DATA POSITION FOR BIT4	T_{RIP4}	$3-T_{\mathrm{EB}}$	3	$3+T_{EB}$	UI
INPUT DATA POSITION FOR BIT5	T_{RIP5}	$4-T_{EB}$	4	4+TEB	UI
INPUT DATA POSITION FOR BIT6	T_{RIP6}	$5-T_{\mathrm{EB}}$	5	$5+T_{EB}$	UI



5.2.2 AC CHARACTERISTICS-2

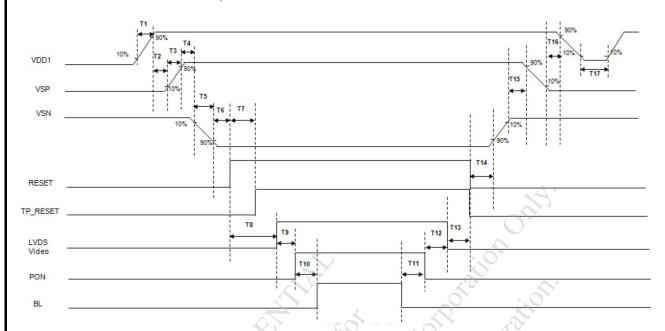
ITEM	SYMBOL	30	UNIT		
TTEM	STWIBUL	MIN.	TYP.	MAX.	UNII
INPUT EYE BORDER(LVDS < 100MHZ)	T_{EB}	7	_	0.25	UI
INPUT EYE BORDER(LVDS≥100MHZ)	T_{EB}	χ \circ $-$	_	0.2	UI
INPUT EYE WIDTH(LVDS < 100MHZ)	$T_{\rm EW}$	0.5	_	_	UI
INPUT EYE WIDTH(LVDS≥100MHZ)	$T_{\rm EW}$	0.6	_	_	UI
MAXIMUM DEVIATION OF INPUT CLOCK FREQUENCY DURING SSC	F_{DEW}	_	_	±3 ⁽¹⁾	%
MAX./MIN. MODULATION	X				
FREQUENCY OF INPUT CLOCK DURING SSC	F_{MOD}	15	_	200	KHZ



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5.3 POWER ON/OFF SEQUENCE



POWER SEQUENCING REQUIREMENTS

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
VDD1 RISE TIME	V T1	0.1	XY.	5	ms
VDD1 TO VSP	T2 _	1			ms
VSP RISE TIME	T3	0.1		10	ms
VSP TO VSN	T4	0	_		ms
VSN RISE TIME	T5	0.1		10	ms
VSN VALID TO RESET VALID	T6	5			ms
RESET VALID TO TP RESET VALID	T7	7 0			ms
RESET VALID TO SIGNAL VALID	T8	0	_		ms
SIGNAL VALID TO PON VALID	T9	16			ms
PON VALID TO BACKLIGHT ON	T10	200			ms
BACKLIGHT OFF TO PON DISABLE	T11	200			ms
PON DISABLE TO SIGNAL DISABLE	T12	6			FRAME
SIGNAL DISABLE TO RESET DISABLE	T13	0	_		ms
RESET DISABLE TO VSN DOWN	T14	0	-	-	ms
VSN DOWN TO VSP DOWN	T15	0	-	-	ms
VSP DOWN TO VDD1 DOWN	T16	0	-		ms
VDD1 NORMAL POWER OFF TO NORMAL POWER ON	T17	100	-	-	ms

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6. OPTICAL CHARACTERISTICS

6.1 OPTICAL CHARACTERISTICS (NOTE 1)

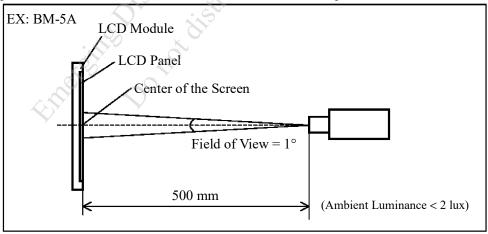
 $Ta=25\pm2$ °C

ITEM		SYMBOL	CONI	DITION	MIN.	TYP.	MAX.	UNIT	REMARK	
		θ_{y^+}		θ _x =0°	(80)	(85)				
VIEWING ANGLE	MIEWING ANGLE		CR ≥ 10		(80)	(85)	_	deg.	NOTE (2)	
VIEWING ANGLE		θ_{x^+}	CR ≥ 10		(80)	(85)		deg.	NOTE (3)	
		θ_{x-}		$\theta_y=0^{\circ}$	(80)	(85)				
CONTRAST RATIO	(CENTER)	CR	0**-00	000	(1100)				NOTE(3)	
RESPONSE TIME		Tr + Tf	$\theta x=0^{\circ}, \ \theta y=0^{\circ}$			25	30	msec	NOTE(4)	
	WHITE	Wx			(0.25)	(0.30)	(0.35)	> >		
	WILLE	Wy		4		(0.33)	(0.38)			
	DED	Rx	4			(0.64)	(0.69)			
COLOR CHROMATICITY	RED	RY		,	(0.27)	(0.32)	(0.37)		NOTE (5)	
(CENTER)	CDEEN	Gx	LEDE	B/L=ON	(0.23)	(0.28)	(0.33)	Ø.	NOTE (5)	
()	GREEN	Gy		=100%	(0.55)	(0.60)	(0.65)	_		
	DLUE	Bx	VBL+-V	BL-=(12V)	(0.09)	(0.14)	(0.19)			
	BLUE	By			(0.05)	(0.10)	(0.15)			
THE BRIGHTNESS		D	.10		(000)	(1000)		. 1/2	NOTE (()	
OF MODULE (CENTER)		B		96	(900)	(1000)		cd/m ²	NOTE (6)	
THE UNIFORMITY OF MODULE		-3	30, 7010,000		(70)			%	NOTE (7)	

NOTE (1): TEST CONDITION:

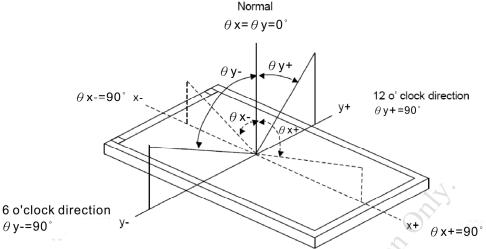
AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM.

THE MEASUREMENT CRITERIA AND CONDITION FOR EITHER BM-5A OR CA-210 OR EQUIVALENT LUMINANCE METER IS BASED ON THE EQUIPMENT'S MANUAL.



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NOTE (2): DEFINITION OF VIEWING ANGLE:

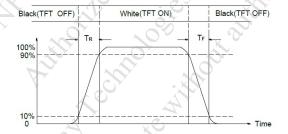


NOTE (3) : DEFINITION OF CONTRAST RATIO (CR) :

MEASURED AT THE CENTER POINT OF MODULE

 $\label{eq:contrast_ratio} \text{CONTRAST RATIO(CR)} = \frac{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"}}{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "BLACK STATE"}}$

NOTE (4): DEFINITION OF RESPONSE TIME: T_R AND T_F
THE FIGURE BELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR.



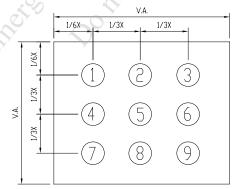
NOTE (5): DEFINITION OF COLOR CHROMATICITY

(a)100% RGB PIXEL DATA TRANSMISSION WHEN ALL THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY POWERED ON.

(b) MEASURED AT THE CENTER POINT OF MODULE

NOTE (6): MEASURED THE BRIGHTNESS OF WHITE STATE AT CENTER POINT.

NOTE (7): (a) DEFINITION OF BRIGHTNESS UNIFORMITY



UNIT: mm

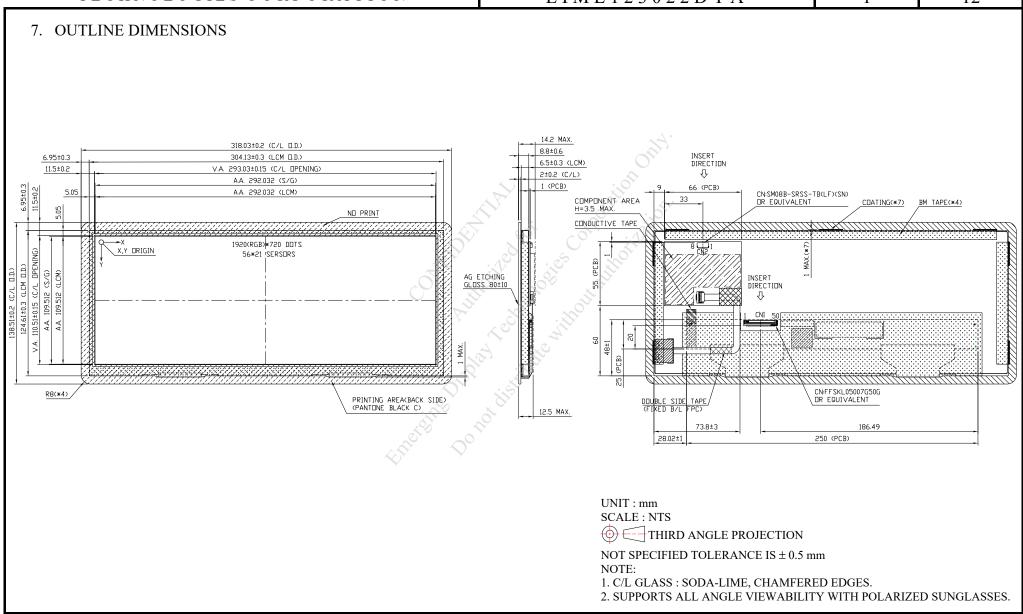
(b)THE BRIGHTNESS UNIFORMITY CALCULATING METHOD

UNIFORMITY: MINIMUM BRIGHTNESS *100%

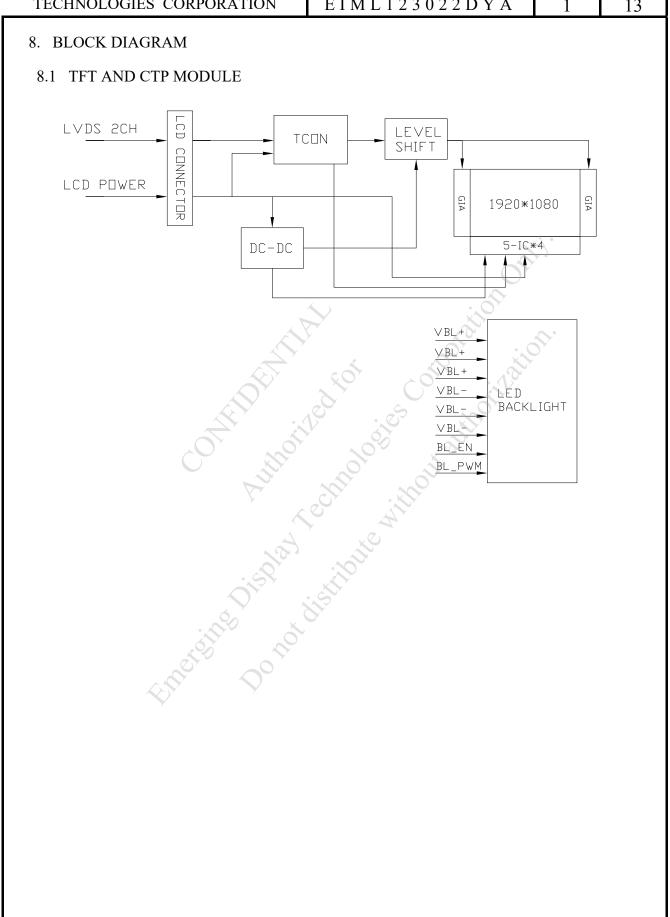
MAXIMUM BRIGHTNESS

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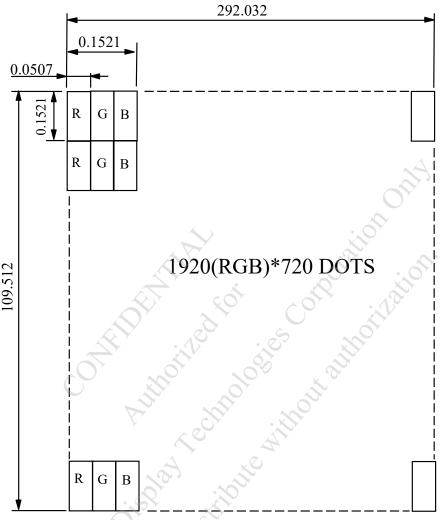
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UNIT : mm SCALE : NTS NOT SPECIFIED TOLERANCE IS \pm 0.1 DOTS MATRIX TOLERANCE IS \pm 0.01

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10. INTERFACE SIGNALS IF1

IF I	CVMDOI	FINCTION
PIN NO.	SYMBOL	FUNCTION EDT INTERNAL USE ONLY(EXT POWER SUPPLY FOR OTP
1	NC	*
2	VCC	CIRCUIT 7.25V)
3	VSS	DIGITAL GROUND
	DA_P_O	LVDS INPUT
4	DA_N_O	LVDS INPUT
5	VSS	DIGITAL GROUND
6	DB_P_O	LVDS INPUT
7	DB_N_O	LVDS INPUT
8	VSS	DIGITAL GROUND
9	DC_P_O	LVDS INPUT
10	DC_N_O	LVDS INPUT
11	VSS	DIGITAL GROUND
12	CLK_P_O	LVDS INPUT
13	CLK_N_O	LVDS INPUT
14	VSS	DIGITAL GROUND
15	DD_P_O	LVDS INPUT
16	DD_N_O	LVDS INPUT
17	VSS	DIGITAL GROUND
18	DA_P_E	LVDS INPUT
19	DA N E	LVDS INPUT
20	VSS	DIGITAL GROUND
21	DB P E	LVDS INPUT
22	DB N E	LVDS INPUT
23	VSS	DIGITAL GROUND
24	DC P E	LVDS INPUT
25	DC N E	LVDS INPUT
26	VSS	DIGITAL GROUND
27	CLK P E	LVDS INPUT
28	CLK N E	LVDS INPUT
29	VSS	DIGITAL GROUND
30	DD P E	LVDS INPUT
31	DD N E	LVDS INPUT
32	VSS	DIGITAL GROUND
33	VDD	DIGITAL GROUND DIGITAL POWER,3.3V
34	VDD	DIGITAL POWER,3.3V
		DIGITAL FOWER,5.5 V DIGITAL POWER,6.5 V
35 36	AVDD NC	NC NC
37		DIGITAL POWER,-6.5V
38	AVEE VSS	
39	TP I2C SDA	DIGITAL GROUND
		I2C INTERFACE DATA SIGNAL FOR TOUCH
40	TP_I2C_SCL TP_I2C_INT	I2C INTERFACE CLOCK SIGNAL FOR TOUCH
41		TOUCH SCREEN INTERRUPT LINE
42	TP_EXT_RSTN	TP EXTERNAL RESET SIGNAL
43	BIST_EN	ENABLE BIST FUNCTION
44	TP_GPIO[0]	USED FOR LOW POWER WAKE UP GESTURE FUNCTION
45	PON	SLPIN/SLPOUT HARDWARE CONTROL SIGNAL
46	TP_GPIO[1]	OUTPUT TOUCH FAIL DETECTION
47	RESX	RESET PIN , D-IC IS INITIALIZED WHEN THIS PIN IS LOW
48	DD_SDI_SDA	I2C INTERFACE DATA SIGNAL FOR OTP
49	DD_SCL	I2C INTERFACE CLOCK SIGNAL FOR OTP
50	FAIL DET	FAIL DETECTION SIGNAL OUTPUT

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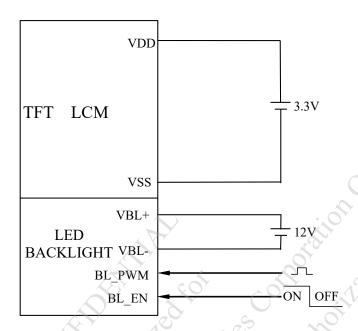
CN2

CINZ	1	
PIN NO.	SYMBOL	FUNCTION
1	VBL+	POWER SUPPLY VOLTAGE FOR LED DRIVER(+)
2	VBL+	POWER SUPPLY VOLTAGE FOR LED DRIVER(+)
3	VBL+	POWER SUPPLY VOLTAGE FOR LED DRIVER(+)
4	VBL-	POWER SUPPLY VOLTAGE FOR LED DRIVER(-)
5	VBL-	POWER SUPPLY VOLTAGE FOR LED DRIVER(-)
6	VBL-	POWER SUPPLY VOLTAGE FOR LED DRIVER(-)
7	BL_EN	BACKLIGHT LED ON/OFF CONTROL
8	BL_PWM	BACKLIGHT LED BRIGHTNESS CONTROL
		POWER SUPPLY VOLTAGE FOR LED DRIVER(-) POWER SUPPLY VOLTAGE FOR LED DRIVER(-) BACKLIGHT LED ON/OFF CONTROL BACKLIGHT LED BRIGHTNESS CONTROL

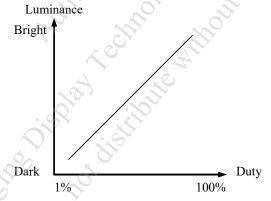
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11. POWER SUPPLY

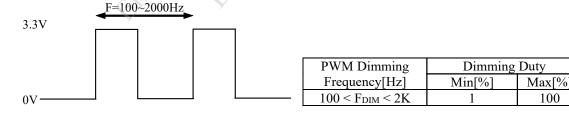
11.1 POWER SUPPLY FOR LCM



NOTE (1) : ADJUST THE PWM SIGNAL IN ORDER TO CONTROL LED BACKLIGHT'S BRIGHTNESS. THE HIGHER THE DUTY CYCLE, THE HIGHER THE BRIGHTNESS



NOTE (2): PWM SIGNAL OPERATION FREQUENCY IS 100~2000 Hz AND DIMMING DUTY.



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12. CAPACITIVE TOUCH PANEL SPECIFICATION

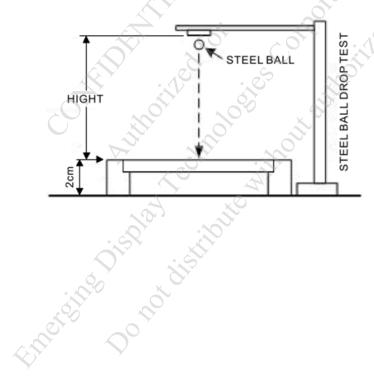
12.1 HARDNESS

ITEM	DESCRIPTION
SURFACE HARDNESS	(7)H (MIN.)

12.2 DURABILITY

USING STEEL BALL AND FALLING ON TOUCH PANEL SURFACE, FROM THE HEIGHT MUST PASS BELOW CONDITIONS:

ITEM	CONDITION	INSPECTION METHOD	DESCRIPTION
STEEL BALL DROP TEST	WEIGHT: 67g HEIGHT OF FALL: 30 cm	VISUAL INSPECTION	SIGN OF FRACTURE OR DAMAGE IS NOT ACCEPTABLE 3 TIME/ 1 POINTS, 25°C (CENTER POINT)



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13 INSPECTION CRITERIA

13.1 APPLICATION

THIS INSPECTION STANDARD IS TO BE APPLIED TO THE LCD MODULE DELIVERED FROM EMERGING DISPLAY TECHNOLOGIES CORP.(E.D.T) TO CUSTOMERS

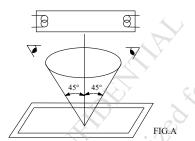
13.2 INSPECTION CONDITIONS

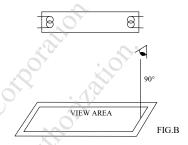
13.2.1 (1)OBSERVATION DISTANCE: 35±5cm

(2) VIEWING ANGLE: ±45°

±45° (FOR SECTION WITHIN VIEWING AREA), REFER TO FIG.A 90° (FOR SECTION OUTSIDE OF VIEWING AREA), REF TO FIG.B PERPENDICULAR TO MODULE SURFACE

VIEWING ANGLE SHOULD BE SMALLER THAN 45°





THE INSPECTION CRITERIA IS ACCORDING TO LINE OF SIGHT. INSPECTION SHALL BE MADE WITHIN THE HALF SECTION OF THE VIEWING CONE GENERATED BY LINE SEGMENT OF 45° WITH RESPECT TO THE VERTICAL AXIS FROM CENTER VERTEX OF LCD, THE FLUORESCENT LAMP AND THE CONE AXIS MUST BE PERPENDICULAR TO THE LCD SURFACE.

IF THE DEFECTS ARE OUTSIDE OF VIEWING AREA, IT SHALL BE INSPECTED BY 90° WITH RESPECT TO THE VERTICAL AXIS FROM EDGE OF VIEWING AREA.

13.2.2 ENVIRONMENT CONDITIONS:

AMBIENT TEMPERATURE		20±5°C
AMBIENT HUMIDITY		$55 \pm 20\%$ RH
AMBIENT	COSMETIC INSPECTION	1000~1200lux
ILLUMINATION	FUNCTIONAL INSPECTION	100~150 lux
INSPECTION TIME		15 secs

13.2.3 INSPECTION LOT

QUANTITY PER DELIVERY LOT FOR EACH MODEL

13.2.4 INSPECTION METHOD

A SAMPLING INSPECTION SHALL BE MADE ACCORDING TO THE FOLLOWING PROVISIONS TO JUDGE THE ACCEPTABILITY (a)APPLICABLE STANDARD:

ANSI/ ASQ Z1.4 NORMAL INSPECTION LEVEL II

(b)AQL: MAJOR DEFECT: AQL 0.65 MINOR DEFECT: AQL 1.0

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13.3 DEFECTS CLASSIFICATION

TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
	1.DISPLAY ON	DEFECT TO MISS SPECIFIED DISPLAY FUNCTION, FOR ALL AND SPECIFIED DOTS EX: DISCONNECTION, SHORT CIRCUIT ETC	
MAJOR DEFECT	2.CTP FUNCTION	NO FUNCTIONBROKEN LINEFALSE TOUCH	0.65
	3.BACKLIGHT	NO LIGHTFLICKERING AND OTHER ABNORMAL ILLUMINATION	
	4.DIMENSIONS	• SUBJECT TO INDIVIDUAL ACCEPTANCE SPECIFICATIONS	
MINOR DEFECT	1.DISPLAY ZONE 2.BEZEL ZONE	 BLACK/WHITE SPOT BUBBLES ON POLARIZER NEWTON RING BLACK/WHITE LINE SCRATCH CONTAMINATION UNEVEN COLOR SPREAD STAINS SCRATCHES FOREIGN MATTER 	1.0
	3.SOLDERING 4.DISPLAY ON (ALL ON)	 INSUFFICIENT SOLDER SOLDERED IN INCORRECT POSITION CONVEX SOLDERING SPOT SOLDER BALLS SOLDER SCRAPS LIGHT LINE 	

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NO.	ITEM	CRITERIA	
1	DISPLAY ON INSPECTION	INCORRECT PATTERN MISSING SEGMENT DIM SEGMENT OPERATING VOLTAGE BEYOND SPEC	
2	OVERALL	OVERALL DIMENSION BEYOND SPEC	
3	DOT DEFECT		
4	BUBBLES ON POLARIZER /SURFACE STAINS /DIRT/CF FAIL/SPOT	2 dot adjacent 2 dot adjacent (vertical) 2 dot adjacent(slant) AVERAGE DIAMETER (mm): D	

EMERGING DISPLAY

TECHNOLOGIES CORPORATION EIML123

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NO.	ITEM		CRITERIA	
۱U.	I I EIVI	THE FOLLOWING DLACK (W	THITE SPOT ARE WITHIN THE	
				/ D
		VIEWING AREA. AVERAGE	` ,	D / D
	BLACK/WHITE	SIZE D	PERMISSIBLE NO.	
5	SPOT CIRCULAR	D≤0.6	IGNORE	
	TYPE	D>0.6	0	
		NOTE (1): THE DISTANCE	E BETWEEN DEFECTS	/ /
		SHOULD BE M	ORE THAN 10mm APART.	
			IS WITHIN THE VIEWING AREA.	
		WIDTH: W (mm), LENGTH:		
		SIZE W & L	PERMISSIBLE NO.	 ← L →
6	SCRATCH	W≤0.3	IGNORE	
		0.3 <w≤0.5, l≤5<="" td=""><td>9</td><td></td></w≤0.5,>	9	
		W>0.5	0	'w
		NOTE (1): THE DISTANCE	E BETWEEN DEFECTS	
		SHOULD BE M	ORE THAN 10mm APART.	
		THE FOLLOWING BLACK LI	NE, WHITE LINE IS WITHIN THE	
		VIEWING AREA. WIDTH: W		Y
	DI ACIZ /	SIZE W & L	PERMISSIBLE NO.	 ← L →
	BLACK /			
7	WHITE LINE	W≤0.3	IGNORE	
	LINEAR TYPE /	0.3 <w≤0.5, l≤5<="" td=""><td>7_O^y</td><td></td></w≤0.5,>	7_O ^y	
	FOREIGN FIBER	W>0.5	0	w
		NOTE (1): THE DISTANCE	E BETWEEN DEFECTS	
		SHOULD BE M	ORE THAN 10mm APART.	Y
		BUBBLES WITHIN VIEWING	AREA.	
		AVERAGE DIAMETER : D (n		
		SIZE D	PERMISSIBLE NO.	
	DIEDRIE (DELE	D≤0.2	IGNORE	D .
	BUBBLE / DENT			
8	FOR OPTICAL	0.2 <d≤0.3< td=""><td>3,</td><td>_()</td></d≤0.3<>	3,	_()
	BONDING	0.3 <d≤0.5< td=""><td>04</td><td></td></d≤0.5<>	04	
		D>0.5	0	
		NOTE (1): THE DISTANCE	E BETWEEN DEFECTS	
		. ,	ORE THAN 10mm APART.	
				Chip of glass
		CORNER	$1 \le 3 \text{mm} \cdot Y \le 3 \text{mm} \cdot Z \le t$	v
9	CHIPPING		(t:THICKNESS)	
9 CHIPPING			7 - 1 7 - 1	2 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
	CIM I II VO	EDGE 2	$X \le 6 \text{mm}, Y \le 1 \text{mm}, Z < t$	
	CIMTING	EDGE 2	$X \le \text{omm}, Y \le \text{Imm}, Z < t$ (t: THICKNESS)	X X
10		EDGE		Y X
10		NOT ACCEPTABLE	(t: THICKNESS)	X _V X
10		EDGE	(t : THICKNESS)	
10		NOT ACCEPTABLE	(t: THICKNESS)	
10		NOT ACCEPTABLE AVERAGE DIAMETER : D (n	(t : THICKNESS)	
10	CRACKED GLASS	NOT ACCEPTABLE AVERAGE DIAMETER : D (n SIZE D D≤0.1	nm) PERMISSIBLE NO. IGNORE	n /
10	CRACKED GLASS PIN HOLE	NOT ACCEPTABLE AVERAGE DIAMETER : D (n SIZE D D≤0.1 0.1 <d≤0.2< td=""><td>nm) PERMISSIBLE NO. IGNORE 5</td><td>D</td></d≤0.2<>	nm) PERMISSIBLE NO. IGNORE 5	D
10	CRACKED GLASS	NOT ACCEPTABLE AVERAGE DIAMETER : D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3<="" td=""><td>nm) PERMISSIBLE NO. IGNORE 5 1</td><td>D</td></d≤0.2>	nm) PERMISSIBLE NO. IGNORE 5 1	D
	CRACKED GLASS PIN HOLE	NOT ACCEPTABLE AVERAGE DIAMETER : D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3</d≤0.2>	nm) PERMISSIBLE NO. IGNORE 5 1 0	D
	CRACKED GLASS PIN HOLE / IMPURITIES	NOT ACCEPTABLE AVERAGE DIAMETER : D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE</d≤0.2>	mm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS	D
	CRACKED GLASS PIN HOLE / IMPURITIES	NOT ACCEPTABLE AVERAGE DIAMETER : D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE</d≤0.2>	nm) PERMISSIBLE NO. IGNORE 5 1 0	D
	CRACKED GLASS PIN HOLE / IMPURITIES	NOT ACCEPTABLE AVERAGE DIAMETER : D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE SHOULD BE M</d≤0.2>	mm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS	D
	CRACKED GLASS PIN HOLE / IMPURITIES	NOT ACCEPTABLE AVERAGE DIAMETER : D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE SHOULD BE M NOTE (2): REFILL INK IS</d≤0.2>	nm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS ORE THAN 10mm APART.	D
11	CRACKED GLASS PIN HOLE / IMPURITIES	NOT ACCEPTABLE AVERAGE DIAMETER: D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE SHOULD BE M NOTE (2): REFILL INK IS ICON PIN HOL</d≤0.2>	nm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS ORE THAN 10mm APART. ACCEPTABLE, BUT LOGO AND E ARE NOT ALLOWED.	
	PIN HOLE / IMPURITIES ON PRINTING	NOT ACCEPTABLE AVERAGE DIAMETER: D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE SHOULD BE M NOTE (2): REFILL INK IS ICON PIN HOL</d≤0.2>	mm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS ORE THAN 10mm APART. ACCEPTABLE, BUT LOGO AND	
11	PIN HOLE / IMPURITIES ON PRINTING LINE DEFECT ON DISPLAY	NOT ACCEPTABLE AVERAGE DIAMETER: D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE SHOULD BE M NOTE (2): REFILL INK IS ICON PIN HOL OBVIOUS VERTICAL OR H</d≤0.2>	nm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS ORE THAN 10mm APART. ACCEPTABLE, BUT LOGO AND E ARE NOT ALLOWED. ORIZONTAL LINE DEFECT IS NO	OT ALLOWED.
11	PIN HOLE / IMPURITIES ON PRINTING LINE DEFECT ON DISPLAY MURA ON	NOT ACCEPTABLE AVERAGE DIAMETER: D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE SHOULD BE M NOTE (2): REFILL INK IS ICON PIN HOL OBVIOUS VERTICAL OR H</d≤0.2>	nm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS ORE THAN 10mm APART. ACCEPTABLE, BUT LOGO AND E ARE NOT ALLOWED.	OT ALLOWED.
11	PIN HOLE / IMPURITIES ON PRINTING LINE DEFECT ON DISPLAY MURA ON DISPLAY	NOT ACCEPTABLE AVERAGE DIAMETER: D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE SHOULD BE M NOTE (2): REFILL INK IS ICON PIN HOL OBVIOUS VERTICAL OR H</d≤0.2>	nm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS ORE THAN 10mm APART. ACCEPTABLE, BUT LOGO AND E ARE NOT ALLOWED. ORIZONTAL LINE DEFECT IS NO	OT ALLOWED.
11 12 13	PIN HOLE / IMPURITIES ON PRINTING LINE DEFECT ON DISPLAY MURA ON DISPLAY UNEVEN COLOR	NOT ACCEPTABLE AVERAGE DIAMETER : D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE SHOULD BE M NOTE (2): REFILL INK IS ICON PIN HOL OBVIOUS VERTICAL OR H IT'S ACCEPTABLE, IF MUR</d≤0.2>	mm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS ORE THAN 10mm APART. ACCEPTABLE, BUT LOGO AND E ARE NOT ALLOWED. ORIZONTAL LINE DEFECT IS NO	OT ALLOWED. H 5% ND FILTER.
11	PIN HOLE / IMPURITIES ON PRINTING LINE DEFECT ON DISPLAY MURA ON DISPLAY UNEVEN COLOR SPREAD,	NOT ACCEPTABLE AVERAGE DIAMETER : D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE SHOULD BE M NOTE (2): REFILL INK IS ICON PIN HOL OBVIOUS VERTICAL OR H IT'S ACCEPTABLE, IF MUR</d≤0.2>	nm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS ORE THAN 10mm APART. ACCEPTABLE, BUT LOGO AND E ARE NOT ALLOWED. ORIZONTAL LINE DEFECT IS NO	OT ALLOWED. H 5% ND FILTER.
11 12 13	PIN HOLE / IMPURITIES ON PRINTING LINE DEFECT ON DISPLAY MURA ON DISPLAY UNEVEN COLOR	NOT ACCEPTABLE AVERAGE DIAMETER : D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE SHOULD BE M NOTE (2): REFILL INK IS ICON PIN HOL OBVIOUS VERTICAL OR H IT'S ACCEPTABLE, IF MUR TO BE DETERMINED BASE</d≤0.2>	mm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS ORE THAN 10mm APART. ACCEPTABLE, BUT LOGO AND E ARE NOT ALLOWED. ORIZONTAL LINE DEFECT IS NO RA IS SLIGHT VISIBLE THROUGH	OT ALLOWED. H 5% ND FILTER.
11 12 13 14	PIN HOLE / IMPURITIES ON PRINTING LINE DEFECT ON DISPLAY MURA ON DISPLAY UNEVEN COLOR SPREAD, COLORATION	NOT ACCEPTABLE AVERAGE DIAMETER : D (n SIZE D D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE SHOULD BE M NOTE (2): REFILL INK IS ICON PIN HOL OBVIOUS VERTICAL OR H IT'S ACCEPTABLE, IF MUR TO BE DETERMINED BASE 1. BEZEL MAY NOT HAVE</d≤0.2>	mm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS ORE THAN 10mm APART. ACCEPTABLE, BUT LOGO AND E ARE NOT ALLOWED. ORIZONTAL LINE DEFECT IS NO RA IS SLIGHT VISIBLE THROUGH ED UPON THE LIMITED SAMPLE. RUST, BE DEFORMED OR HAVE	OT ALLOWED. H 5% ND FILTER.
11 12 13	PIN HOLE / IMPURITIES ON PRINTING LINE DEFECT ON DISPLAY MURA ON DISPLAY UNEVEN COLOR SPREAD,	NOT ACCEPTABLE AVERAGE DIAMETER : D (not size Dosol.) D≤0.1 0.1 <d≤0.2 0.2<d≤0.3="" d="">0.3 NOTE (1): THE DISTANCE SHOULD BE ME NOTE (2): REFILL INK IS ICON PIN HOLE OBVIOUS VERTICAL OR HEIT'S ACCEPTABLE, IF MURTO BE DETERMINED BASE 1. BEZEL MAY NOT HAVE PRINTS STAINS OF OTHER</d≤0.2>	mm) PERMISSIBLE NO. IGNORE 5 1 0 E BETWEEN DEFECTS ORE THAN 10mm APART. ACCEPTABLE, BUT LOGO AND E ARE NOT ALLOWED. ORIZONTAL LINE DEFECT IS NO RA IS SLIGHT VISIBLE THROUGH ED UPON THE LIMITED SAMPLE. RUST, BE DEFORMED OR HAVE	OT ALLOWED. H 5% ND FILTER.

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NO. ITEM	4 CRITERIA
1121	1. THERE MAY NOT BE MORE THAN 2mm OF SEALANT OUTSIDE THE SEAL AREA ON THE PCB, AND THERE SHOULD BE NO MORE THAN THREE PLACES. 2. NO OXIDATION OR CONTAMINATION ON PCB TERMINALS. 3. PARTS ON PCB MUST BE THE SAME AS ON THE PRODUCTION
16 PCB	CHARACTERISTIC CHART. THERE SHOULD BE NO WRONG PARTS, MISSING PARTS OR EXCESS PARTS. 4. THE JUMPER ON THE PCB SHOULD CONFORM TO THE PRODUCT CHARACTERISTIC CHART. 5. IF SOLDER GETS ON BEZEL TAB PADS, LED PAD, ZEBRA PAD OR SCREW HOLD PAD; MAKE SURE IT IS SMOOTHED DOWN.
17 SOLDERING	SCREW HOLD PAD; MAKE SURE IT IS SMOOTHED DOWN. 1. NO SOLDERING FOUND ON THE SPECIFIED PLACE 2. INSUFFICIENT SOLDER (a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD SOLDER FILLET (b)CHIP COMPONENT SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED SOLDER 3. PARTS ALIGNMENT (a)LSI, IC LEAD WIDTH IS MORE THAN 50% BEYOND PAD OUTLINE (b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE 4. NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB. 5. NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS, OXIDATION OR ICICLE. 6. NO RESIDUE OR SOLDER BALLS ON PCB. 7. NO SHORT CIRCUITS IN COMPONENTS ON PCB.

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NO	ITEM	CDITEDIA
NO.	ITEM	CRITERIA
18	BACKLIGHT	 NO LIGHT FLICKERING AND OTHER ABNORMAL ILLUMINATION SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGED USING LCD SPOT, LINES AND CONTAMINATION STANDARDS. BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.
19	GENERAL APPEARANCE	 BACKLIGHT BOESN T EIGHT ON COLOK IS WRONG. NO OXIDATION, CONTAMINATION, CURVES OR, BENDS ON INTERFACE PIN (OLB) OF TCP. NO CRACKS ON INTERFACE PIN (OLB) OF TCP. NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON PRODUCT. THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS. THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE INTERFACE PIN TO SEVER. THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING (COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO BROWN OR BLACK COLOR. SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED. PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET. LCD PIN LOOSE OR MISSING PINS. PRODUCT PACKAGING MUST BE THE SAME AS SPECIFIED ON PACKAGING SPECIFICATION SHEET. PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO PRODUCT SPECIFICATION SHEET. THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY DIRT AND BREAK.
		Alife Display destribite without

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14 RELIABILITY TEST

14.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO.	ITEM	DESCRIPTION	
1	HIGH TEMPERATURE TEST (OPERATION)	THE SAMPLE SHOULD BE ALLOWED TO STAND AT (+70°C) FOR 240 HRS	
2	LOW TEMPERATURE TEST (OPERATION)	THE SAMPLE SHOULD BE ALLOWED TO STAND AT (-20°C) FOR 240 HRS	
3	HIGH TEMPERATURE TEST (STORAGE)	THE SAMPLE SHOULD BE ALLOWED TO STAND AT (+80°C) FOR 240 HRS	
4	TEST (STORAGE)	THE SAMPLE SHOULD BE ALLOWED TO STAND AT (-30°C) FOR 240 HRS	
5	HIGH TEMPERATURE / HUMIDITY TEST (OPERATION)	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C, 90% RH 240 HRS	
6	THERMAL SHOCK TEST (NOT OPERATED)	THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION: (-30°C) (-30°C) (-30°C) (-30°C)	
7	VIBRATION (NOT OPERATED)	11.76 m/s ² (1.2G), 10~100 Hz XYZ DIRECTIONS, 1 HR EACH	
8	(NOT OPERATED)	490.0 m/s ² (50G), 10 ms XYZ DIRECTIONS, 1 TIME EACH	
9	(ELECTROSTATIC DISCHARGE)	AIR DISCHARGE ± 12KV CONTACT DISCHARGE ± 8KV (ACCORDING TO IEC-61000-4-2)	

NOTE (1): THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.

NOTE (2): WHEN THE LCD MODULE IS OPERATED AT A HIGHER AMBIENT TEMPERATURE THAN 60°C, THE PWM DUTY CYCLE OF THE LED BACKLIGHT SHOULD BE ADJUSTED TO BE LESS THAN TBD%. IF THE MODULE IS OPERATED AT A HIGHER DUTY CYCLE THAN TBD, THEN THERE IS A POSSIBILITY OF DISTORTION AND IRREGULARITY OF THE PICTURE DUE TO LIQUID CRYSTAL BEHAVIOR.

NOTE (3): TESTING CONDITIONS AND INSPECTION CRITERIA

NO.	ITEM	TEST MODEL	INSPECTION CRITERIA
1 1	CURRENT CONSUMPTION	L REFER TO SPECIFICATION	THE CURRENT CONSUMPTION SHOULD CONFORM TO THE PRODUCT SPECIFICATION.
2	CONTRAST	REFER TO SPECIFICATION	AFTER THE TESTS HAVE BEEN EXECUTED, THE CONTRAST MUST BE LARGER THAN HALF OF ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE

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15. CAUTION

15.1 OPERATION

- 15.1.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THEMAIN SYSTEM WHILE POWER IS BEING SUPPLIED .
- 15.1.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR.

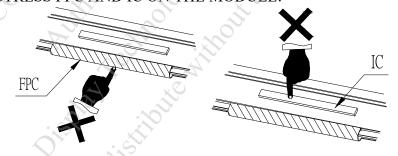
 WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY
- 15.1.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST.

WILL OPERATE NORMALLY.

- 15.1.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND REACHES THE SPECIFIED VALUE.

 IF ABOVE SEQUENCE IS NOT FOLLOWED, CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH UP PROBLEM.
- 15.1.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS!

 DO NOT STRESS FPC AND IC ON THE MODULE!



15.2 STORAGE

- 15.2.1 STORE THE MODULE IN A DARK ROOM OR KEEP IN ORIGINAL PACKAGE WHERE MUST KEEP AT 25±10°C AND 65%RH OR LESS.
- 15.2.2 DO NOT STORE THE MODULE IN SURROUNDINGS CONTAINING ORGANIC SOLVENT OR CORROSIVE GAS.
- 15.2.3 STORE THE MODULE IN AN ANTI-ELECTROSTATIC CONTAINER OR BAG.

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15.3 NOTICE

- 15.3.1 USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS . FOR SOLDERING OR REPAIRING, TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGHHOLE-PAD .
- 15.3.2 DO NOT DISASSEMBLE . EDT SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED .
- 15.3.3 DO NOT CHARGE STATIC ELECTRICITY, AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP. WORKING CLOTHES FOR SUCH PERSONNEL SHOULD BE OF STATIC-PROTECTED MATERIAL.
- 15.3.4 ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE.
- 15.3.5 DON'T GIVE EXTERNAL SHOCK.
- 15.3.6 DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.
- 15.3.7 LIQUID IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW.

 WHEN THE LIQUID IS ATTACH TO YOUR, SKIN, CLOTH ETC.

 WASH IT OUT THOROUGHLY AND IMMEDIATELY.
- 15.3.8 DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.
- 15.3.9 STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS AND SOLVENT.
- 15.3.10 STORE WITHOUT ANY PHYSICAL LOAD.
- 15.3.11 REWIRING: NO MORE THAN 3 TIMES.